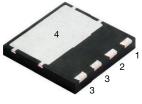
**Vishay Siliconix** 

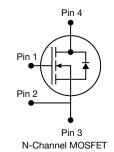


### **E Series Power MOSFET**

PRODUCT SUMMARY					
V <sub>DS</sub> (V) at T <sub>J</sub> max.	700				
R <sub>DS(on)</sub> typ. (Ω) at 25 °C	$V_{GS} = 10 V$	0.148			
Q <sub>g</sub> max. (nC)	99				
Q <sub>gs</sub> (nC)	16				
Q <sub>gd</sub> (nC)	28				
Configuration	Single				

#### PowerPAK<sup>®</sup> 8 x 8





### FEATURES

- Completely lead (Pb)-free device
- Low figure-of-merit (FOM) Ron x Qg
- Low input capacitance (Ciss)
- Reduced switching and conduction losses
- Ultra low gate charge (Qg)
- Avalanche energy rated (UIS)
- Kelvin connection for reduced gate noise
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

#### APPLICATIONS

- · Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
  - Welding
  - Induction heating
  - Motor drives
  - Battery chargers
  - Renewable energy
  - Solar (PV inverters)

ORDERING INFORMATION	
Package	PowerPAK 8 x 8
Lead (Pb)-free and Halogen-free	SiHH21N65E-T1-GE3

<b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>C</sub> = 25 °C, unless otherwise noted)						
PARAMETER	SYMBOL	LIMIT	UNIT			
Drain-Source Voltage	V <sub>DS</sub>	650	V			
Gate-Source Voltage		V <sub>GS</sub>	± 30	V		
Continuous Drain Current (T, = 150 °C)	$V_{GS} \text{ at } 10 \text{ V} \qquad \frac{T_{C} = 25 \text{ °C}}{T_{C} = 100 \text{ °C}}$	Ι <sub>D</sub>	20.3			
Continuous Drain Current $(I_{\rm J} = 150^{\circ} {\rm C})$			12.8	А		
Pulsed Drain Current <sup>a</sup>		I <sub>DM</sub>	53			
Linear Derating Factor			1.47	W/°C		
Single Pulse Avalanche Energy <sup>b</sup>	E <sub>AS</sub>	353	mJ			
Maximum Power Dissipation	PD	156	W			
Operating Junction and Storage Temperature Ran	rating Junction and Storage Temperature Range		-55 to +150	°C		
Drain-Source Voltage Slope	T <sub>J</sub> = 125 °C	dV/dt	70	- V/ns		
Reverse Diode dV/dt <sup>c</sup>		uv/dt	17	v/ns		

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b.  $V_{DD}$  = 140 V, starting T<sub>J</sub> = 25 °C, L = 28.2 mH, R<sub>g</sub> = 25  $\Omega$ , I<sub>AS</sub> = 5 A.

c.  $I_{SD} \leq I_D,\, dI/dt$  = 100 A/µs, starting  $T_J$  = 25 °C.

1





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THERMAL RESISTANCE RATI	NGS							
PARAMETER	SYMBOL	TYP.		MAX.		UNIT		
Maximum Junction-to-Ambient	R <sub>thJA</sub>	39		51			°0 4 4	
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	0.51		0.68			°C/W	
<b>SPECIFICATIONS</b> ( $T_J = 25 \ ^{\circ}C$ , u	Inless otherwi	se noted)						
PARAMETER	SYMBOL		T CONDIT	IONS	MIN.	TYP.	MAX.	UNIT
Static								1
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> =	= 0 V, I <sub>D</sub> = 2	250 μA	650	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C,	I <sub>D</sub> = 1 mA	-	0.81	-	V/°C
Gate-Source Threshold Voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	· V <sub>GS</sub> , I <sub>D</sub> = 2	250 μA	2.0	-	4.0	V
			$V_{\rm GS} = \pm 20$		-	-	± 100	nA
Gate-Source Leakage	I <sub>GSS</sub>		$V_{\rm GS} = \pm 30$	V	-	-	± 1	μA
		$V_{DS} = 650 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$		-	-	1	, r	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 520 V	, V <sub>GS</sub> = 0 V	, T <sub>J</sub> = 125 °C	-	-	25	μA
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V		<sub>0</sub> = 11 A	-	0.148	0.170	Ω
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub>	= 30 V, I <sub>D</sub> =	: 11 A	-	8.5	-	S
Dynamic		1 -				1		1
Input Capacitance	C <sub>iss</sub>		V <sub>GS</sub> = 0 V,		-	2404	-	-
Output Capacitance	C <sub>oss</sub>	- -	V <sub>DS</sub> = 100 \	Ι,	-	102	-	
Reverse Transfer Capacitance	C <sub>rss</sub>	f = 1 MHz		-	2	-		
Effective Output Capacitance, Energy Related <sup>a</sup>	C <sub>o(er)</sub>	$V_{DS} = 0$ V to 520 V, $V_{GS} = 0$ V		-	75	-	pF	
Effective Output Capacitance, Time Related <sup>b</sup>	C <sub>o(tr)</sub>			-	314	-		
Total Gate Charge	Qg				-	66	99	
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V I <sub>D</sub> = 11 A, V <sub>DS</sub> = 520 V		-	16	-	nC	
Gate-Drain Charge	Q <sub>gd</sub>				-	28	-	
Turn-On Delay Time	t <sub>d(on)</sub>				-	26	52	
Rise Time	t <sub>r</sub>	V <sub>DD</sub> =	= 520 V, I <sub>D</sub> =	= 11 A,	-	46	92	- ns
Turn-Off Delay Time	t <sub>d(off)</sub>		= 10 V, R <sub>g</sub> =		-	69	104	
Fall Time	t <sub>f</sub>				-	44	88	
Gate Input Resistance	R <sub>g</sub>	f = 1 MHz, open drain		0.27	0.55	1.10	Ω	
Drain-Source Body Diode Characteristi		•			·			
Continuous Source-Drain Diode Current	١ <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	20.3	•	
Pulsed Diode Forward Current	I <sub>SM</sub>			-	-	53	A	
Diode Forward Voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C, I <sub>S</sub> = 11 A, V <sub>GS</sub> = 0 V		-	0.9	1.2	V	
Reverse Recovery Time	t <sub>rr</sub>				-	396	792	ns
Reverse Recovery Charge	Q <sub>rr</sub>	$T_J = 25 \ ^{\circ}C$ , $I_F = I_S = 11 \ A$ , dI/dt = 100 A/µs, $V_R = 25 \ V$		-	6.2	12.4	μC	
Reverse Recovery Current	I <sub>RRM</sub>			-	26	-	Α	

#### Notes

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DS}$ . b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DS}$ .



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#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

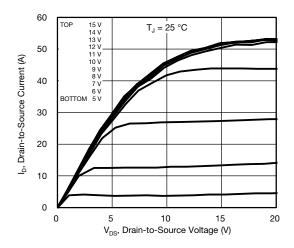
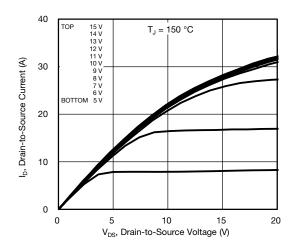
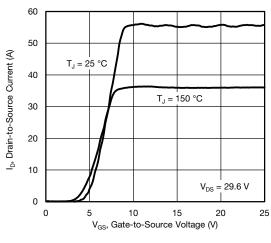


Fig. 1 - Typical Output Characteristics









3.0 0.5 0.5 0.6

Fig. 4 - Normalized On-Resistance vs. Temperature

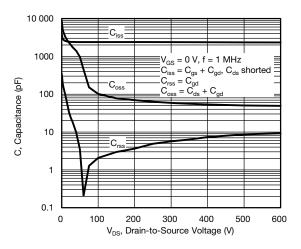


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

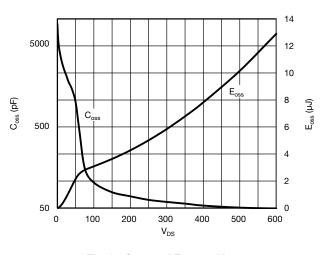


Fig. 6 -  $C_{\text{OSS}}$  and  $E_{\text{OSS}}$  vs.  $V_{\text{DS}}$ 

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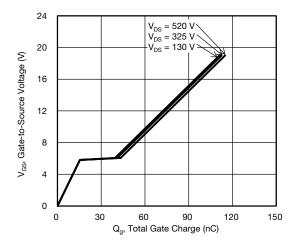


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

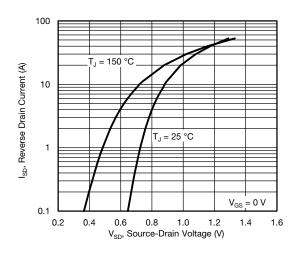


Fig. 8 - Typical Source-Drain Diode Forward Voltage

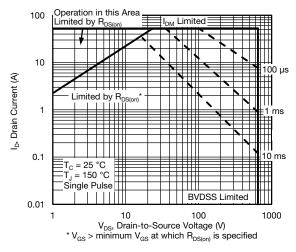


Fig. 9 - Maximum Safe Operating Area

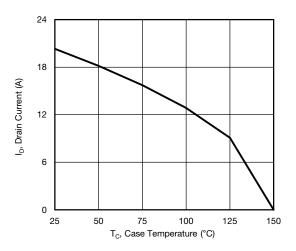


Fig. 10 - Maximum Drain Current vs. Case Temperature

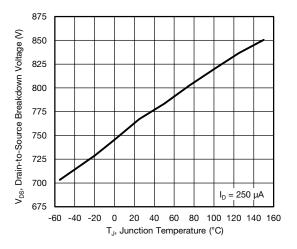
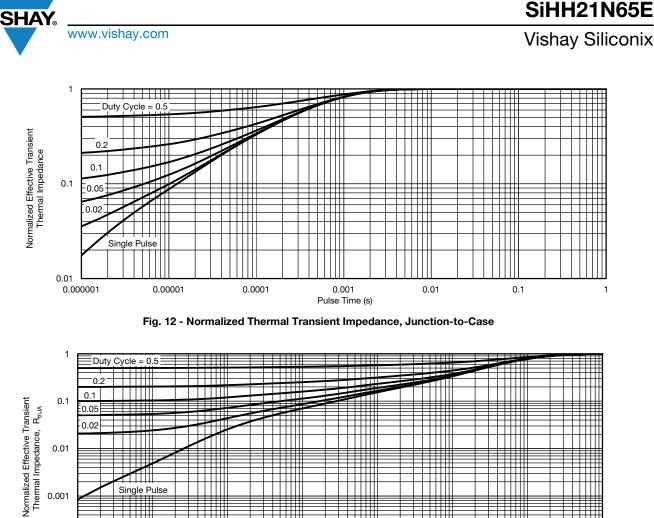


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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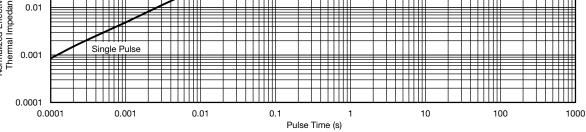


Fig. 13 - Normalized Thermal Transient Impedance, Junction-to-Ambient

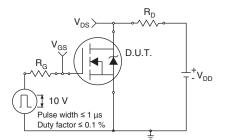


Fig. 14 - Switching Time Test Circuit

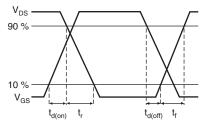


Fig. 15 - Switching Time Waveforms

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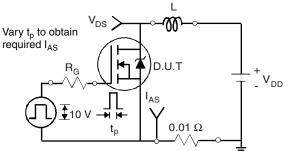
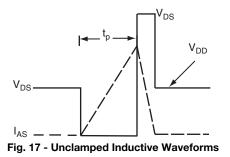


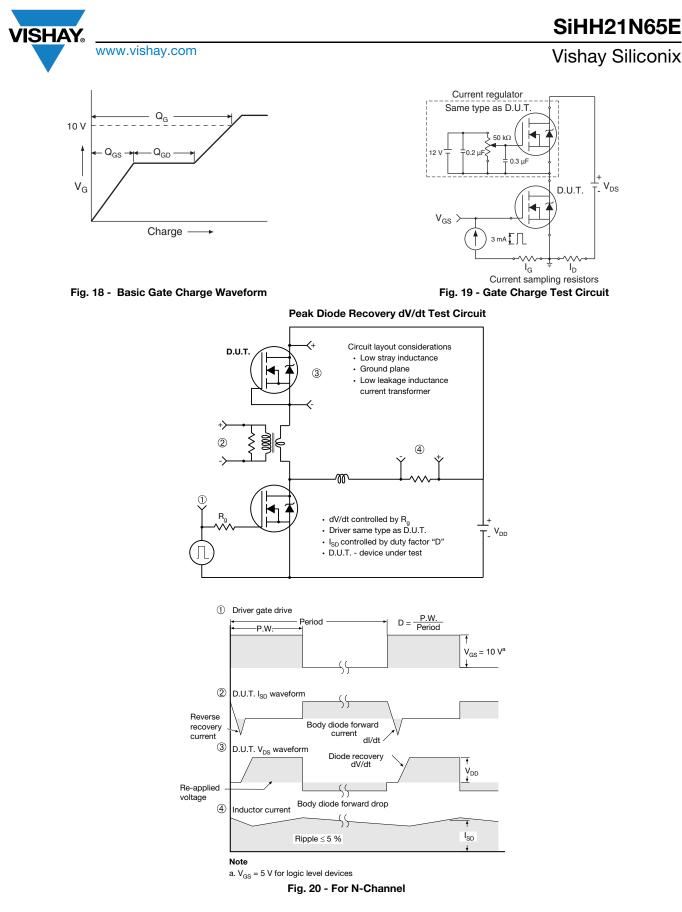
Fig. 16 - Unclamped Inductive Test Circuit



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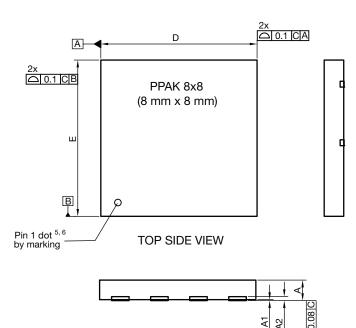


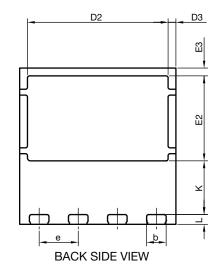
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# PowerPAK<sup>®</sup> 8 x 8 Case Outline





DIM.	MILLIMETERS			INCHES			
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
A <sup>8</sup>	0.95	1.00	1.05	0.037	0.039	0.041	
A1	0.00	-	0.05	0.000	-	0.002	
A2		020 ref.		020 ref. 0.008 ref.			
b <sup>4</sup>	0.95	1.00	1.05	0.037	0.039	0.041	
D	7.90	8.00	8.10	0.311	0.315	0.319	
D2	7.10	7.20	7.30	0.280	0.283	0.287	
D3		0.40 BSC		0.016 BSC			
e		2.00 BSC		0.079 BSC			
E	7.90	8.00	8.10	0.311	0.315	0.319	
E2	4.30	4.35	4.40	0.169	0.171	0.173	
E3	0.40 BSC		0.016 BSC				
К		2.75 BSC		0.108 BSC			
L	0.45	0.50	0.55	0.018	0.020	0.022	
N <sup>3</sup>		8		8			

D

#### Notes

1. Use millimeters as the primary measurement.

2. Dimensioning and tolerances conform to ASME Y14.5 M - 1994.

3. N is the number of terminals.

4. Package warpage max. 0.08 mm.

5. The pin 1 identifier must be existed on the top surface of the package by using indentation mark or other feature of package body.

6. Exact shape and size of this feature is optional.

ECN: T15-0225-Rev. A, 18-May-15 DWG: 6041

Revision: 18-May-15

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# Recommended Minimum PADs for PowerPAK<sup>®</sup> 8 mm x 8 mm



**Dimensions in millimeters** 

Document Number: 68441



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